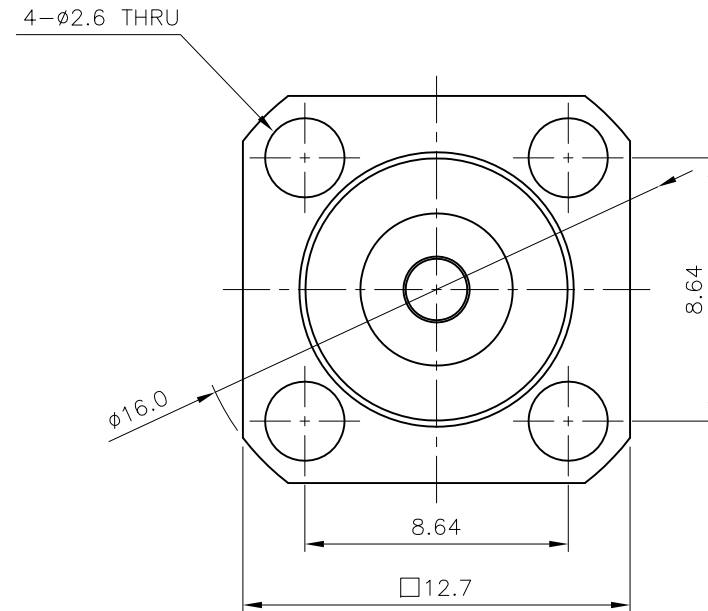
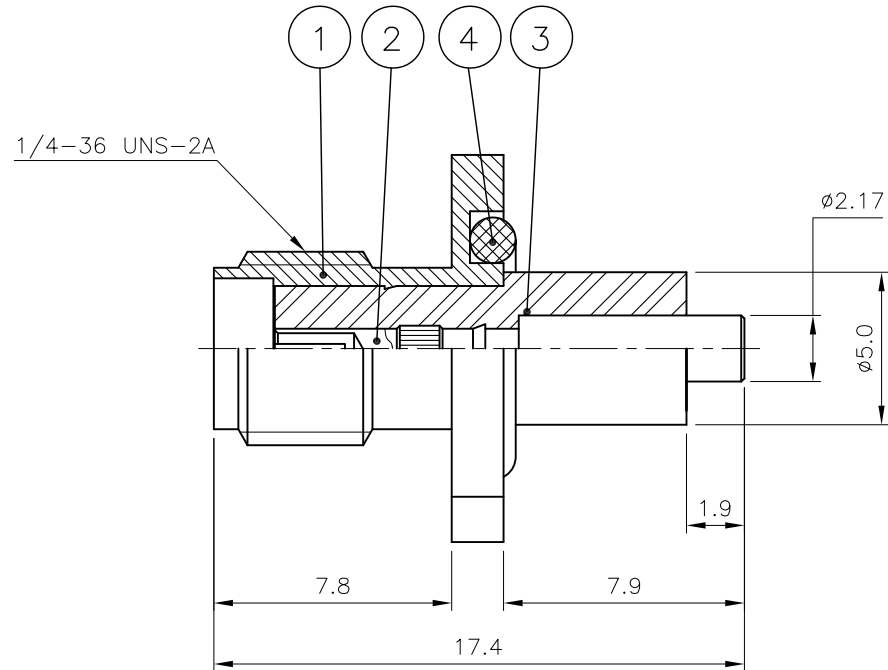


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	T.J.KIM	J.H.YOUN	2014.10.07.



4	GASKET	1	SILICONE RUBB		DGK00020-N/1
3	INSULATOR	1	TEFLON		DIN002466-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT03245-5/2
1	BODY	1	MBsBD	Nickel Plate	DBD03734-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 10. 07.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	J.H.YOUN	
MATERIAL	_____	CHECKED BY	S.L.SON	KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-4H
		DRAWN BY	T.J.KIM	
FINISH	_____	SCALE	4/1	A4 DWG NO. CN03302-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	